



PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

June 17, 2004
Date

Carolyn L. Ross
Carolyn L. Ross

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 09/616,794

Confirmation No. : 9185

Applicant : Jason B. Elledge

Filed : July 14, 2000

Attorney Docket No.: 500188.02

Art Unit : 3723

Customer No. : 27,076

Examiner : Shantese L. McDonald

Title : APPARATUS FOR IN-SITU OPTICAL ENDPOINTING ON WEB-FORMAT
PLANARIZING MACHINES IN MECHANICAL OR CHEMICAL-MECHANICAL
PLANARIZATION OF MICROELECTRONIC-DEVICE SUBSTRATE ASSEMBLIES
AND METHODS FOR MAKING AND USING SAME

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. §§ 1.56 and 1.97 through 1.98, applicant wishes to make known to the Patent and Trademark Office the references set forth on the attached form PTO-1449. This application relies, under 35 U.S.C. § 120, on the earlier filing date of prior Application No. 09/300,358, filed April 26, 1999. The references listed on the attached Form PTO-1449 were submitted to and/or cited by the Patent and Trademark Office in this prior application and, therefore, are not required to be provided in this application. If the Examiner wishes, copies will be provided upon request. Although the aforesaid references are made known to the Patent and

Trademark Office in compliance with applicant's duty to disclose all information he is aware of which is believed relevant to the examination of the above-identified application, applicant believes that his invention is patentable.

Please acknowledge receipt of this Supplemental Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

Respectfully submitted,

DORSEY & WHITNEY LLP



Mark W. Roberts, Ph.D.
Registration No. 46,160

Enclosures:

Fee Transmittal (+ copy)
Form PTO-1449

1420 Fifth Avenue, Suite 3400
Seattle, WA 98101-4010
Telephone: (206) 903-8800
Facsimile: (206) 903-8820

H:\IP\Documents\Clients\Micron Technology\100\500188.02\500188.02 Supp IDS.doc

FORM PTO-1449
(REV. 7-80)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

ATTY. DOCKET NO.

500188.02

APPLICATION NO.

09/616,794

INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

APPLICANT(S)

Jason B. Elledge

FILING DATE

July 14, 2000

GROUP ART UNIT

3723

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
AA	6,426,232	07/30/02	Litvak	438	8	
AB	6,323,046	11/27/01	Agarwal	438	8	
AC	6,285,035	09/04/01	Taravade	250	559.22	
AD	6,241,847	06/05/01	Allman et al.	438	8	
AE	6,121,147	09/19/00	Daniel et al.	438	692	
AF	6,074,517	06/13/00	Taravade	156	345.13	
AG	5,948,203	09/07/99	Wang	156	345.03	
AH	5,872,633	02/16/99	Holzappel et al.	356	630	
AI	5,851,135	12/22/98	Sandhu et al.	451	5	
AJ	5,834,375	11/10/98	Chen	438	692	
AK	5,730,642	03/24/98	Sandhu et al.	451	6	
AL	5,700,180	12/23/97	Sandhu et al.	451	5	
AM	5,667,424	09/16/97	Pan	451	6	
AN	5,648,847	07/15/97	Ebbing	356	150	
AO	5,643,050	07/01/97	Chen	451	10	
AP	5,439,551	08/08/95	Meikle et al.	438	5	
AQ	5,433,651	07/18/95	Lustig et al.	451	6	
AR	5,413,941	05/09/95	Koos et al.	438	16	
AS	5,337,144	08/09/94	Strul et al.	356	357	
AT						

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

AU	Erkanat, Judy, "Applied Materials' Mirra chemical mechanical polishing system," <i>Electronic News 41</i> (2094): p.1, 1991
----	---

AV	Applied Materials, "Dielectric Deposition," http://www.appliedmaterials.com/products/pdd.html , printed 3/2/99
----	---

EXAMINER

DATE CONSIDERED

* EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).